

Features

- Floating channel designed for bootstrap operation
- Fully operational to +600 V
- Tolerant to negative transient voltage, dV/dt immune
- Gate drive supply range from 10 V to 20 V
- Undervoltage lockout for both channels
- 3.3 V and 5 V input logic compatible
- Matched propagation delay for both channels
- Logic and power ground +/- 5 V offset
- Lower di/dt gate driver for better noise immunity
- Output source/sink current capability (typical) 1.9 A /2.3 A
- Leadfree, RoHS compliant
- Automotive qualified*

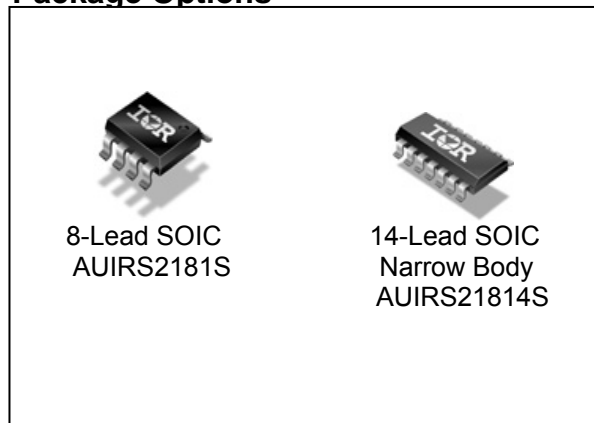
Typical Applications

- Piezo/ common rail Injection
- Starter/Alternator
- Electric Power Steering
- Fan and compressor

Product Summary

Topology	High and Low Side Driver
V _{OFFSET}	≤ 600 V
V _{OUT}	10 V – 20 V
I _{o+} & I _{o-} (typical)	1.9 A & 2.3 A
t _{ON} & t _{OFF} (typical)	160 ns & 200 ns

Package Options



Typical Connection

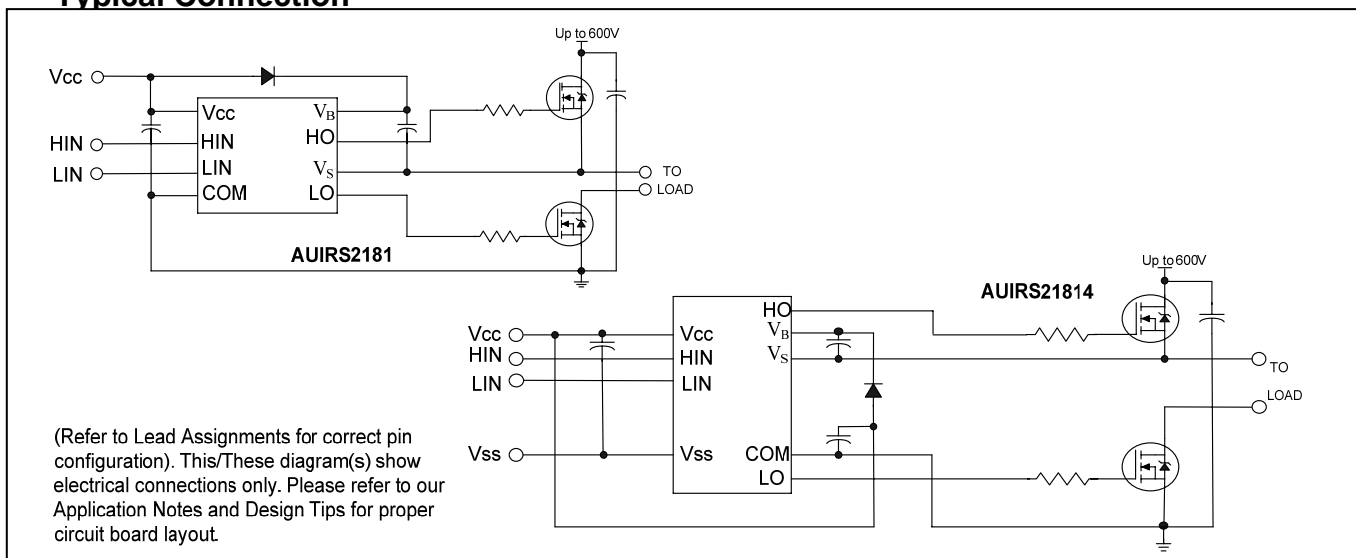


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Description

The AUIRS2181(4)(S) are high voltage, high speed power MOSFET and IGBT drivers with independent high and low-side referenced output channels. Proprietary HVIC and latch immune CMOS technologies enable ruggedized monolithic construction. The logic input is compatible with standard CMOS or LSTTL output, down to 3.3 V logic. The output drivers feature a high pulse current buffer stage designed for minimum driver cross-conduction. The floating channel can be used to drive an N-channel power MOSFET or IGBT in the high-side configuration which operates up to 600 V.

Feature Comparison: AUIRS2181/AUIRS2183/AUIRS2184

Part	Input Logic	Cross-Conduction Prevention logic	Dead-Time	Ground Pins	Ton/Toff
2181	HIN/LIN	no	none	COM	160/200 ns
21814				V _{SS} /COM	
2183	HIN/LIN	yes	Internal 500ns Programmable 0.4 – 5 us	COM	160/200 ns
21834				V _{SS} /COM	
2184	IN/SD	yes	Internal 500ns Programmable 0.4 – 5 us	COM	600/230 ns
21844				V _{SS} /COM	

Qualification Information[†]

Qualification Level		Automotive (per AEC-Q100 ^{††})	
		Comments: This family of ICs has passed an Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.	
Moisture Sensitivity Level		SOIC8	MSL3 ^{†††} 260°C (per IPC/JEDEC J-STD-020)
		SOIC14N	MSL3 ^{†††} 260°C (per IPC/JEDEC J-STD-020)
ESD	Machine Model	Class M2 (Pass +/-150V) (per AEC-Q100-003)	
	Human Body Model	Class H1B (Pass +/-1000V) (per AEC-Q100-002)	
	Charged Device Model	Class C4 (Pass +/-1000V) (per AEC-Q100-011)	
IC Latch-Up Test		Class II, Level A ^{†††} (per AEC-Q100-004)	
RoHS Compliant		Yes	

† Qualification standards can be found at International Rectifier's web site <http://www.irf.com/>

†† Exceptions to AEC-Q100 requirements are noted in the qualification report.

††† Higher MSL ratings may be available for the specific package types listed here. Please contact your International Rectifier sales representative for further information.

†††† HIN, LIN Class II Level B at 80mA per JESD78.

Absolute Maximum Ratings

Absolute Maximum Ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM lead. Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the "Recommended Operating Conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (T_A) is 25°C, unless otherwise specified.

Symbol	Definition	Min	Max	Units	
V_B	High-side floating absolute voltage	-0.3	625	V	
V_S	High-side floating supply offset voltage	$V_B - 25$	$V_B + 0.3$		
V_{HO}	High-side floating output voltage	$V_S - 0.3$	$V_B + 0.3$		
V_{CC}	Low-side and logic fixed supply voltage	-0.3	20 ^(†)		
V_{LO}	Low-side output voltage	-0.3	$V_{CC} + 0.3$		
V_{IN}	Logic input voltage (HIN & LIN)	$V_{SS} - 0.3$	$V_{CC} + 0.3$		
V_{SS}	Logic ground (AUIRS21814(S) only)	$V_{CC} - 20$	$V_{CC} + 0.3$		
dV_S/dt	Allowable offset supply voltage transient	—	50	V/ns	
P_D	Package power dissipation @ $T_A \leq 25^\circ\text{C}$	(8 lead SOIC)	—	0.625	W
		(14 lead SOIC)	—	1.0	
R_{thJA}	Thermal resistance, junction to ambient	(8 lead SOIC)	—	200	°C/W
		(14 lead SOIC)	—	120	
T_J	Junction temperature	—	150	°C	
T_S	Storage temperature	-50	150		
T_L	Lead temperature (soldering, 10 seconds)	—	300		

† All supplies are fully tested at 25 V and an internal 20 V clamp exists for each supply.

Recommended Operating Conditions

The input/output logic timing diagram is shown in figure 1. For proper operation the device should be used within the recommended conditions. The V_S and V_{SS} offset rating are tested with all supplies biased at 15 V differential.

Symbol	Definition	Min	Max	Units
V_B	High-side floating supply absolute voltage	$V_S + 10$	$V_S + 20$	V
V_S	High-side floating supply offset voltage	^(††)	600	
V_{HO}	High-side floating output voltage	V_S	V_B	
V_{CC}	Low-side and logic fixed supply voltage	10	20	
V_{LO}	Low-side output voltage	0	V_{CC}	
V_{IN}	Logic input voltage ^(†††)	V_{SS}	V_{CC}	
DT	Programmable deadtime pin voltage	V_{SS}	V_{CC}	
V_{SS}	Logic ground	-5	5	
T_A	Ambient temperature	-40	125	°C

†† Logic operational for V_S of -5 V to +600 V. Logic state held for V_S of -5 V to $-V_{BS}$. (Please refer to the Design Tip DT97-3 for more details).

††† HIN and LIN are internally clamped with a 5.2 V zener diode.

Dynamic Electrical Characteristics

Unless otherwise noted, these specifications apply for an operating junction temperature range of $-40^{\circ}\text{C} \leq T_j \leq 125^{\circ}\text{C}$ with bias conditions of $V_{\text{BIAS}} (V_{\text{CC}}, V_{\text{BS}}) = 15\text{ V}$, $V_{\text{SS}} = \text{COM}$, $C_L = 1000\text{ pF}$.

Symbol	Definition	Min	Typ	Max	Units	Test Conditions
t_{on}	Turn-on propagation delay	—	160	270	ns	$V_S = 0\text{ V}$
t_{off}	Turn-off propagation delay	—	200	330		$V_S = 0\text{ V}$ or 600 V
MT	Delay matching, HS & LS turn-on/off	—	—	35		
t_r	Turn-on rise time	—	15	60		$V_S = 0\text{ V}$
t_f	Turn-off fall time	—	15	35		

Static Electrical Characteristics

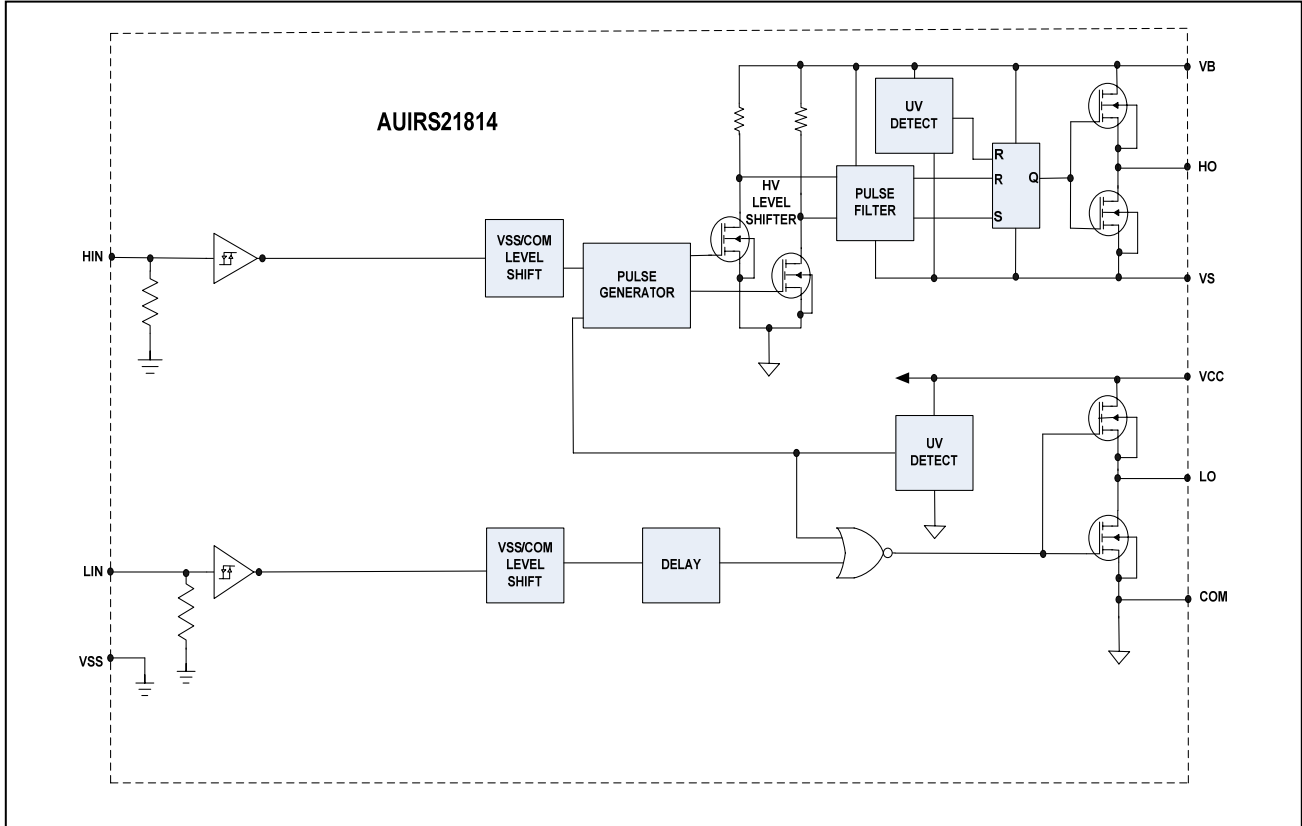
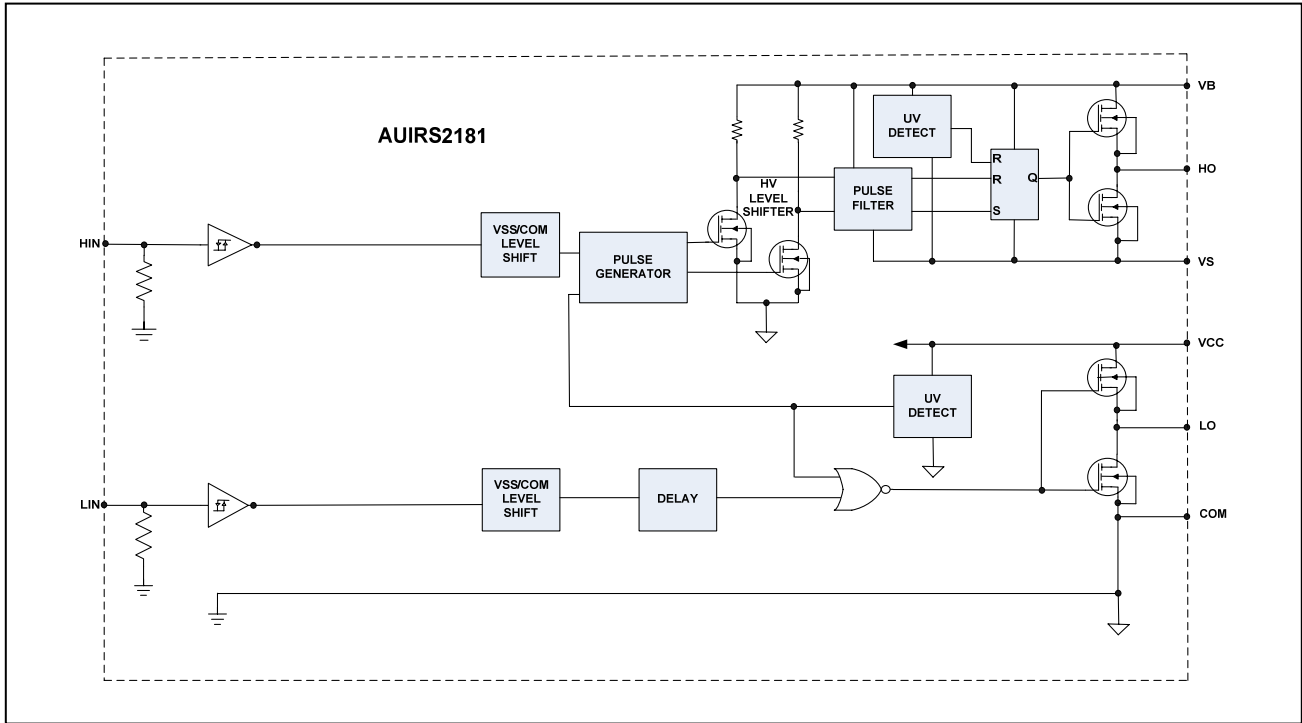
Unless otherwise noted, these specifications apply for an operating junction temperature range of $-40^{\circ}\text{C} \leq T_j \leq 125^{\circ}\text{C}$ with bias conditions of $V_{\text{BIAS}} (V_{\text{CC}}, V_{\text{BS}}) = 15\text{ V}$, $V_{\text{SS}} = \text{COM}$. The V_{IL} , V_{IH} and I_{IN} parameters are referenced to V_{SS}/COM and are applicable to the respective input leads: HIN and LIN. The V_{O} , I_{O} and R_{on} parameters are referenced to COM and are applicable to the respective output leads: HO and LO.

Symbol	Definition	Min	Typ	Max	Units	Test Conditions
V_{IH}	Logic "1" input voltage	2.5	—	—	V	$V_{\text{CC}} = 10\text{ V}$ to 20 V
V_{IL}	Logic "0" input voltage	—	—	0.8		$V_{\text{CC}} = 10\text{ V}$ to 20 V
V_{OH}	High level output voltage, $V_{\text{BIAS}} - V_{\text{O}}$	—	—	1.4		$I_{\text{O}} = 0\text{ mA}$
V_{OL}	Low level output voltage, V_{O}	—	—	0.2		$I_{\text{O}} = 20\text{ mA}$
I_{LK}	Offset supply leakage current	—	—	50	μA	$V_{\text{B}} = V_{\text{S}} = 600\text{ V}$
I_{QBS}	Quiescent V_{BS} supply current	15	60	150		$V_{\text{IN}} = 0\text{ V}$ or 5 V
I_{QCC}	Quiescent V_{CC} supply current	15	120	240		
$I_{\text{IN}+}$	Logic "1" input bias current	—	25	60		$V_{\text{IN}} = 5\text{ V}$
$I_{\text{IN}-}$	Logic "0" input bias current	—	—	5.0	$V_{\text{IN}} = 0\text{ V}$	
$V_{\text{CCUV}+}$ $V_{\text{BSUV}+}$	V_{CC} and V_{BS} supply undervoltage positive going threshold	8.0	8.9	9.8	V	
$V_{\text{CCUV}-}$ $V_{\text{BSUV}-}$	V_{CC} and V_{BS} supply undervoltage negative going threshold	7.4	8.2	9.0		
V_{CCUVH} V_{BSUVH}	V_{CC} and V_{BS} supply undervoltage Hysteresis	0.3	0.7	—		
$I_{\text{O}25+}^{(\dagger)}$	Output high short circuit pulsed current	1.4	1.9	—	A	$V_{\text{O}} = 0\text{ V}$, $\text{PW} \leq 10\mu\text{s}$, $T_J = 25^{\circ}\text{C}$
$I_{\text{O}25-}^{(\dagger)}$	Output low short circuit pulsed current	1.8	2.3	—		$V_{\text{O}} = 15\text{ V}$, $\text{PW} \leq 10\mu\text{s}$, $T_J = 25^{\circ}\text{C}$
$I_{\text{O}+}^{(\dagger)(\ddagger)}$	Output high short circuit pulsed current	1.2	—	—		$V_{\text{O}} = 0\text{ V}$, $\text{PW} \leq 10\text{ }\mu\text{s}$
$I_{\text{O}-}^{(\dagger)(\ddagger)}$	Output low short circuit pulsed current	1.5	—	—		$V_{\text{O}} = 15\text{ V}$, $\text{PW} \leq 10\text{ }\mu\text{s}$

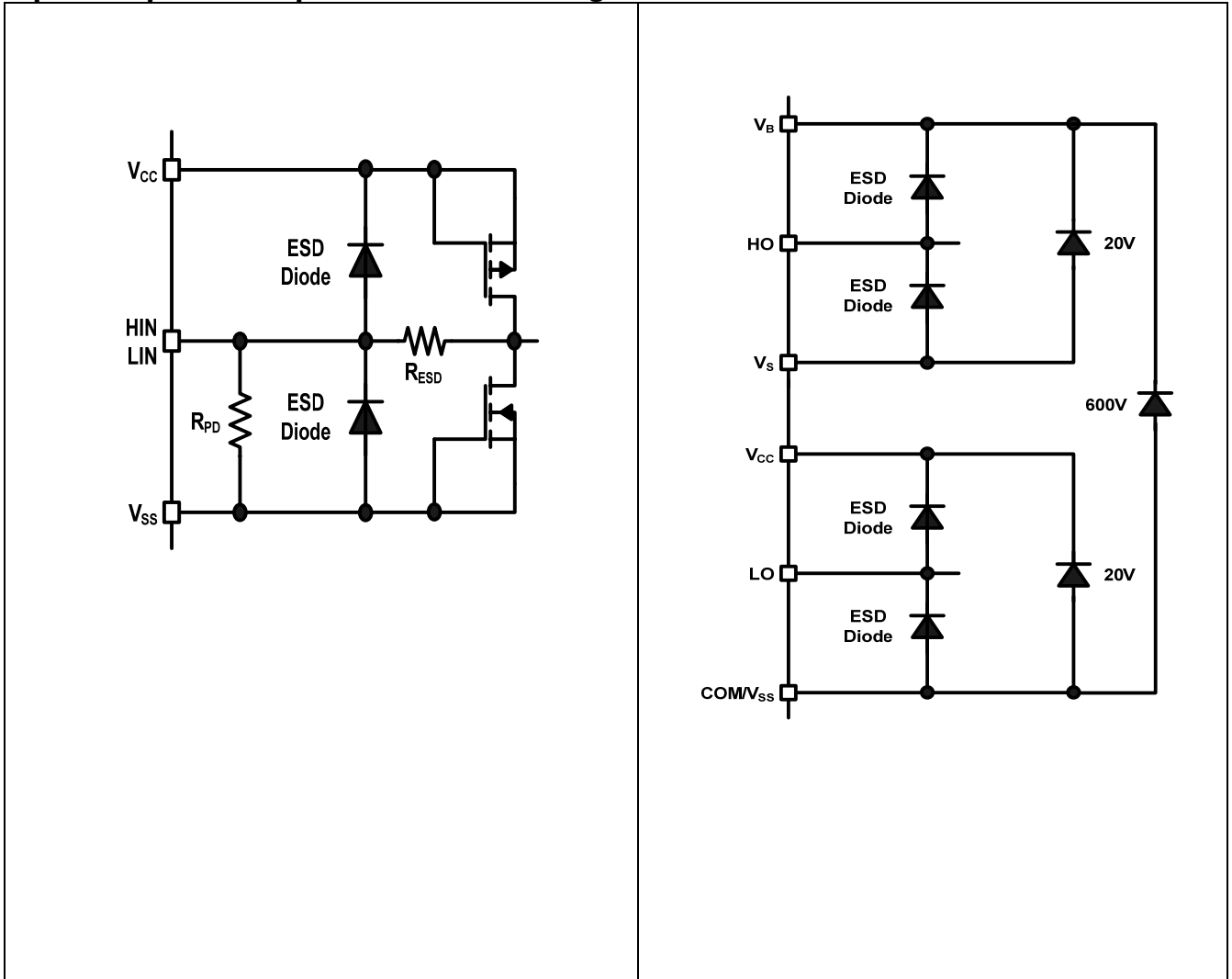
(†) Guaranteed by design

(‡) $I_{\text{O}+}$ and $I_{\text{O}-}$ decrease with rising temperature

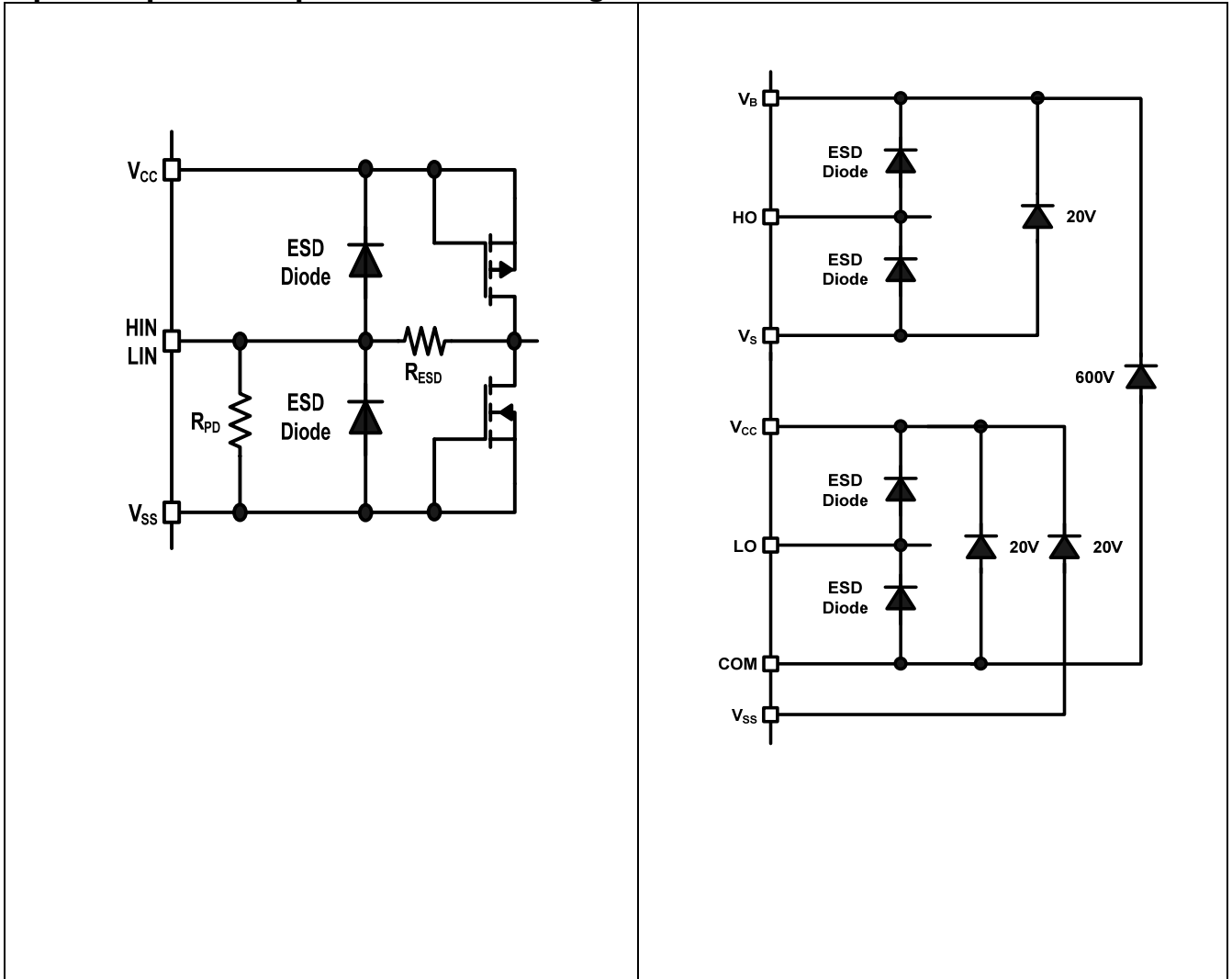
Functional Block Diagrams: AUIRS2181, AUIRS21814



Input/Output Pin Equivalent Circuit Diagrams: AUIRS2181S



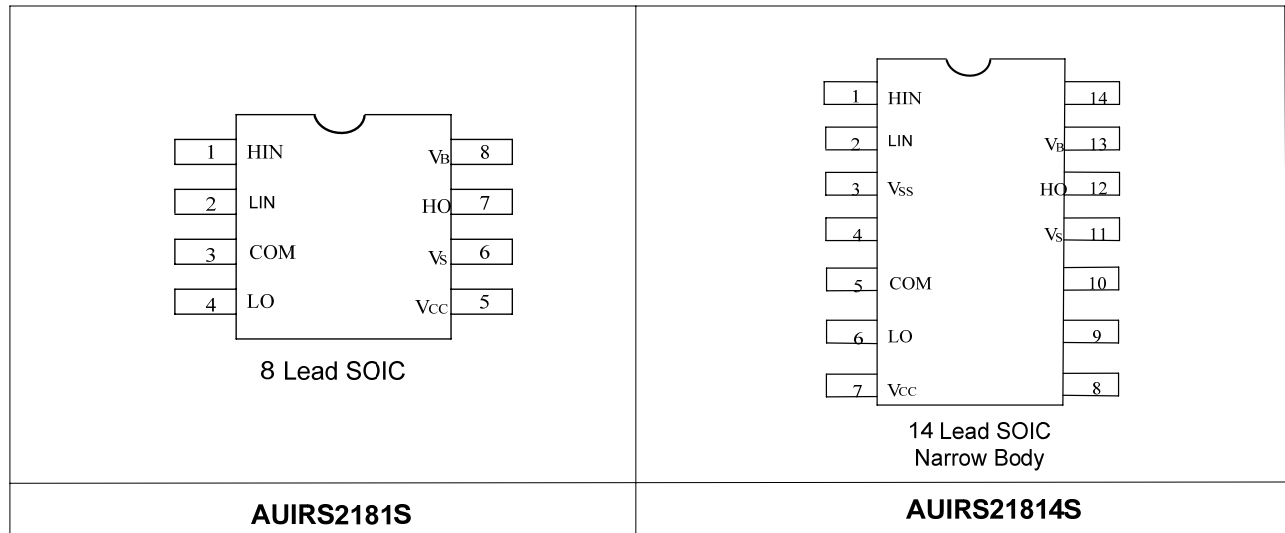
Input/Output Pin Equivalent Circuit Diagrams: AUIRS21814S



Lead Definitions: AUIRS2181(4)S

Symbol	Description
HIN	Logic input for high-side gate driver output (HO), in phase
LIN	Logic input for low-side driver output (LO), in phase
V _{SS}	Logic ground (AUIRS21814 only)
V _B	High-side floating supply
HO	High-side gate drive output
V _S	High-side floating supply return
V _{CC}	Low-side and logic fixed supply
LO	Low-side gate drive output
COM	Low-side return

Lead Assignments: AUIRS2181(4)S



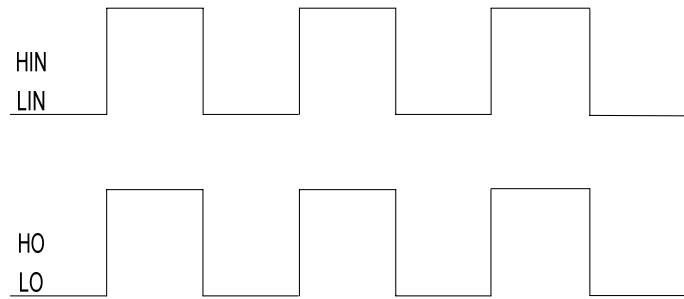


Figure 1. Input/Output Timing Diagram

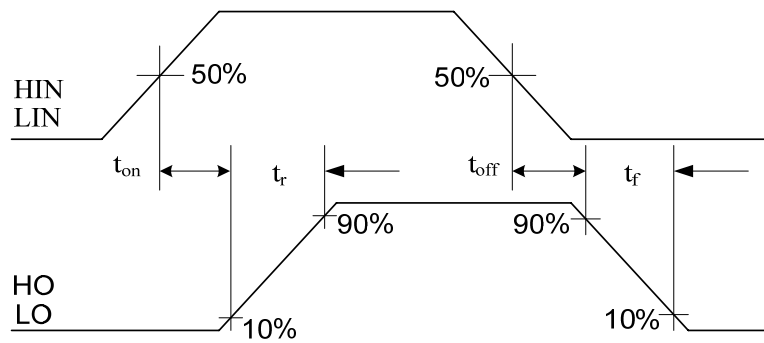


Figure 2. Switching Time Waveform Definitions

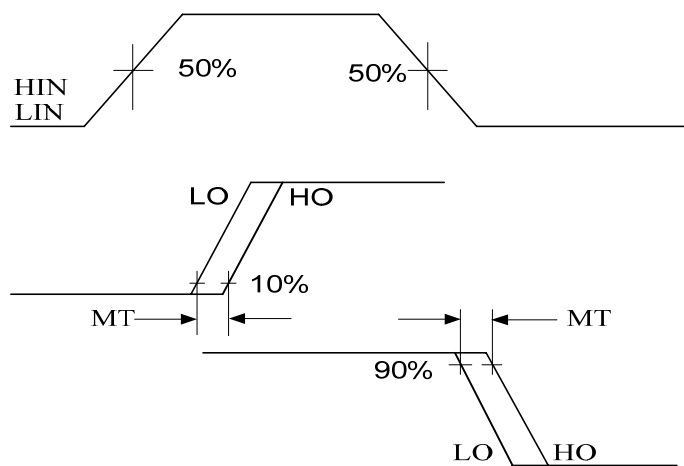


Figure 3. Delay Matching Waveform Definitions

Parameter Trends vs. Temperature and vs. Supply Voltage

Figures of this chapter provide information on the experimental performance of the AUIRS2181(4)S HVIC. The line plotted in each figure is generated from actual lab data.

A large number of individual samples were tested at three temperatures (-40 °C, 25 °C, and 125 °C) in order to generate the experimental curve. The line consists of three data points (one data point at each of the tested temperatures) that have been connected together to illustrate the understood trend. The individual data points on the Typ. curve were determined by calculating the averaged experimental value of the parameter (for a given temperature).

A different set of individual samples was used to generate curves of parameter trends vs. supply voltage.

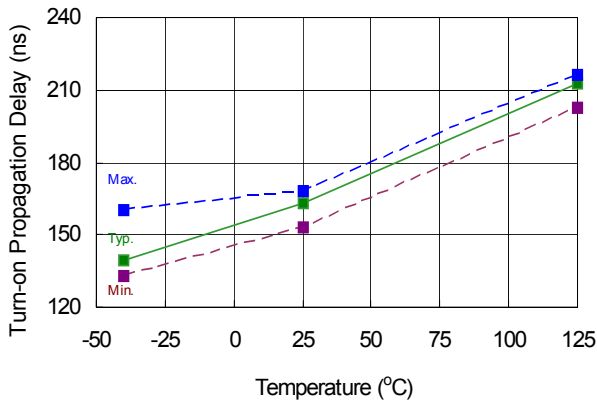


Figure 1A. Turn-On Propagation Delay vs. Temperature

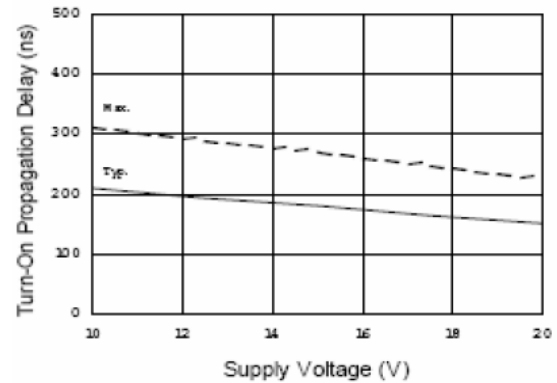


Figure 1B. Turn-On Propagation Delay vs. Supply Voltage

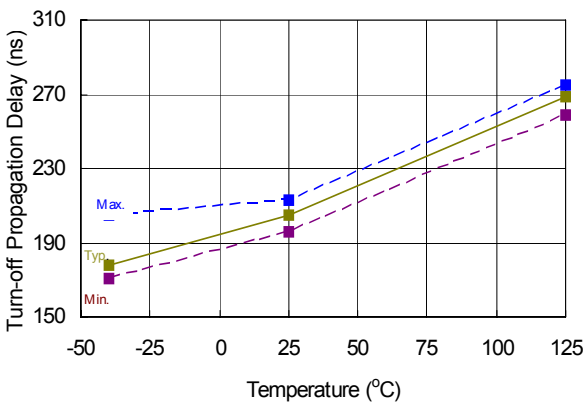


Figure 2A. Turn-Off Propagation Delay vs. Temperature

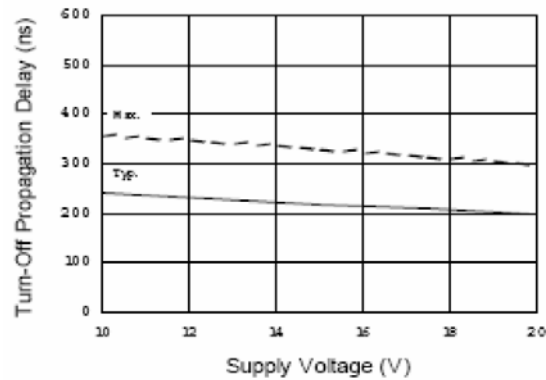


Figure 2B. Turn-Off Propagation Delay vs. Supply Voltage

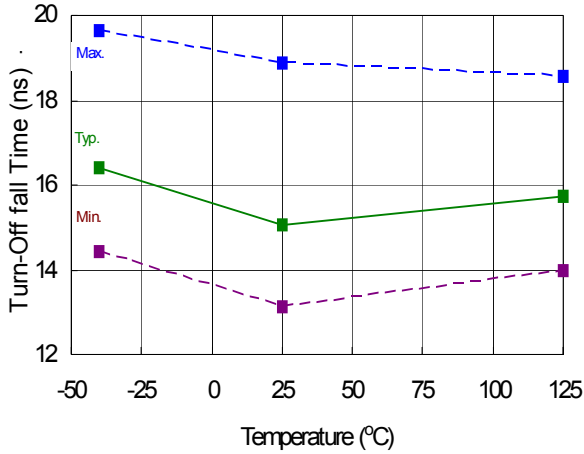


Figure 3A. Turn-Off Fall Time vs. Temperature

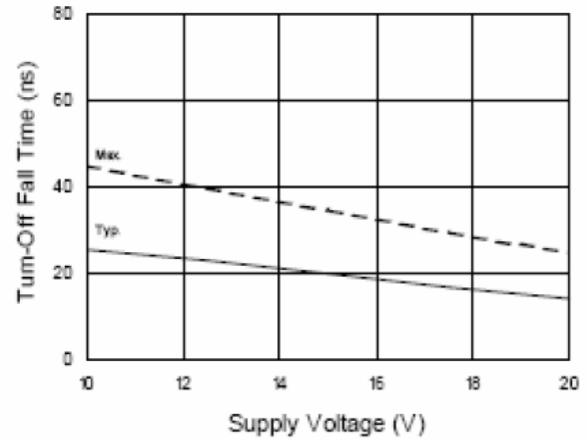


Figure 3B. Turn-Off Fall Time vs. Supply Voltage

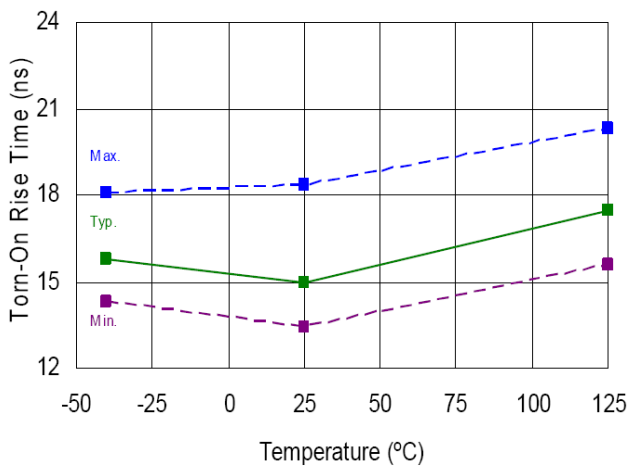


Figure 4. Turn-On Rise Time vs. Temperature

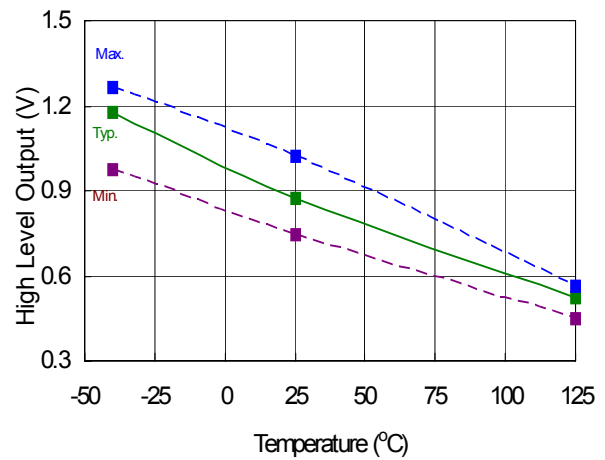


Figure 5. High Level Output Voltage vs. Temperature (Io = 0mA)

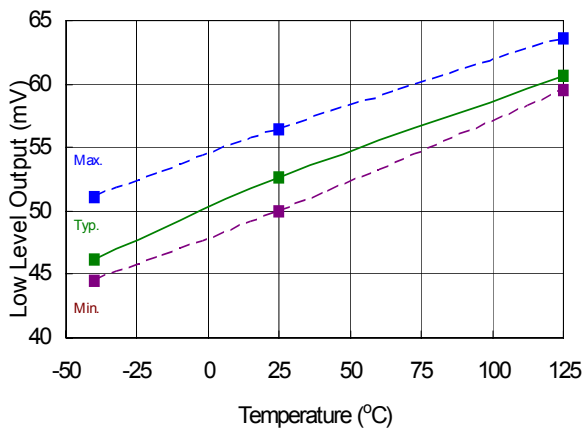


Figure 6. Low Level Output vs. Temperature

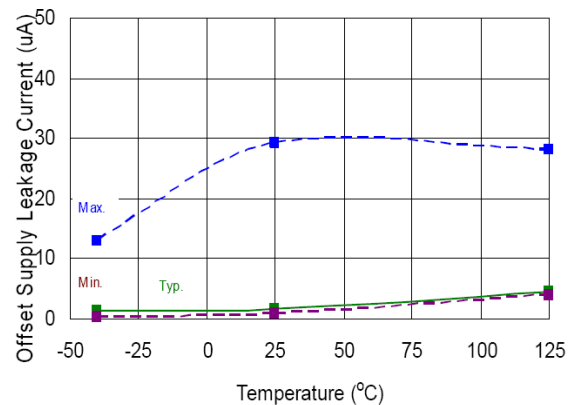


Figure 7. Offset Supply Leakage Current vs. Temperature

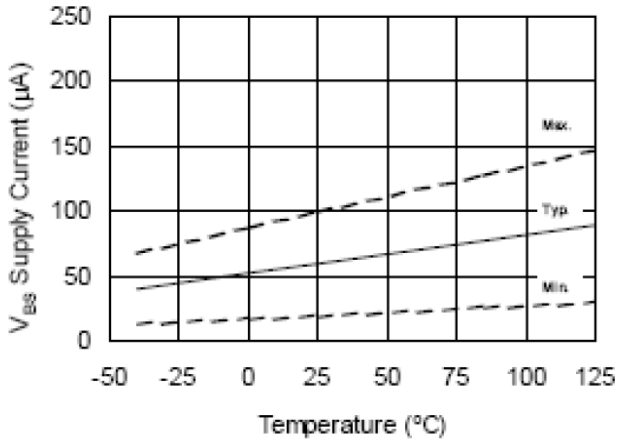


Figure 8A V_{BS} Supply Current vs. Temperature

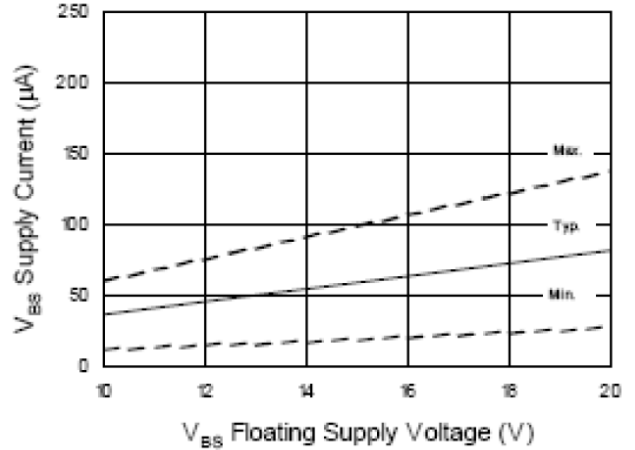


Figure 8B V_{BS} Supply Current vs. V_{BS} Floating Supply Voltage

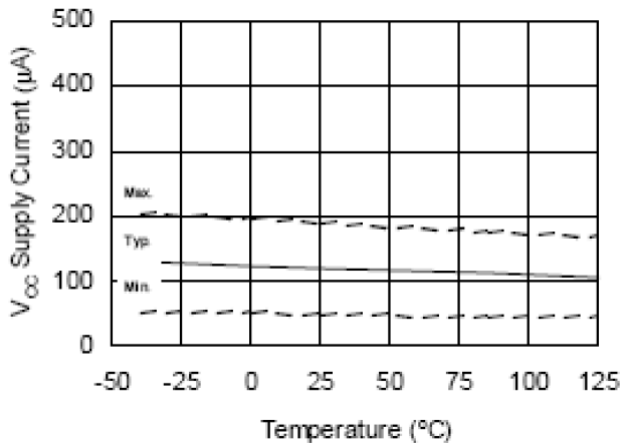


Figure 9A V_{CC} Supply Current vs. Temperature

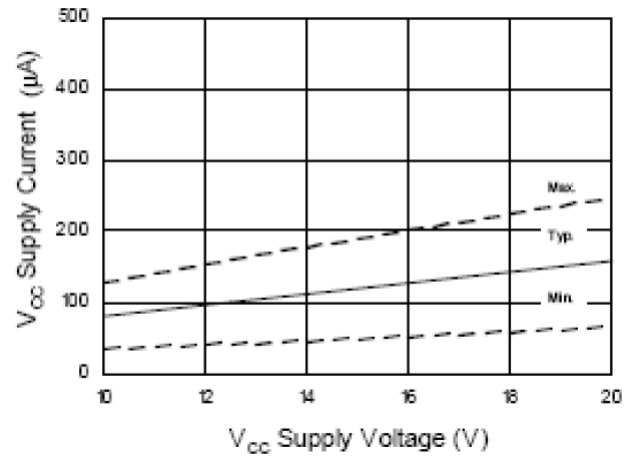


Figure 9B V_{CC} Supply Current vs. V_{CC} Supply Voltage

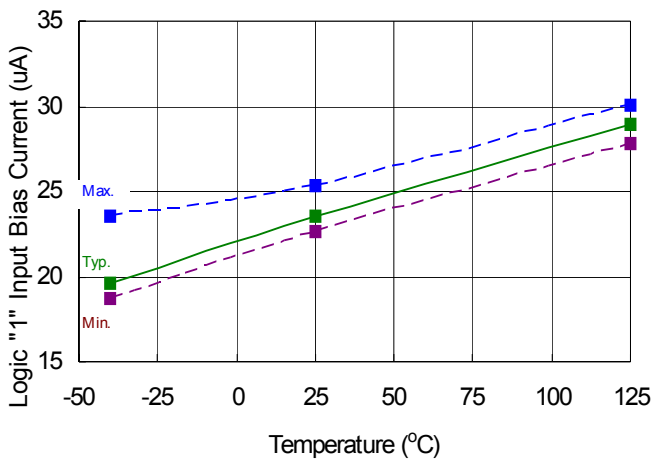


Figure 10. Logic "1" Input Bias vs. Temperature

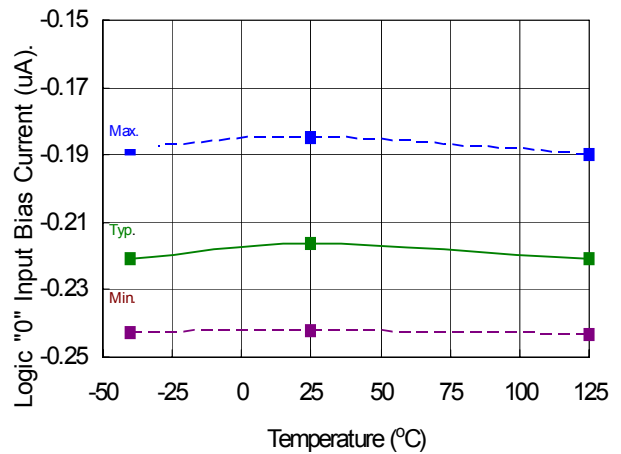


Figure 11. Logic "0" Input Bias vs. Temperature

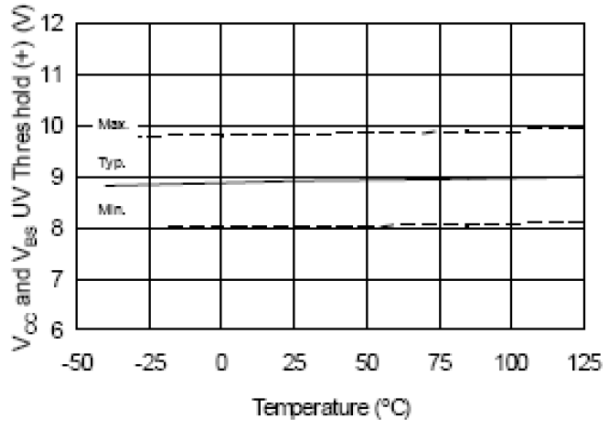


Figure 12. V_{CC} and V_{BS} Undervoltage Threshold(+) vs Temperature

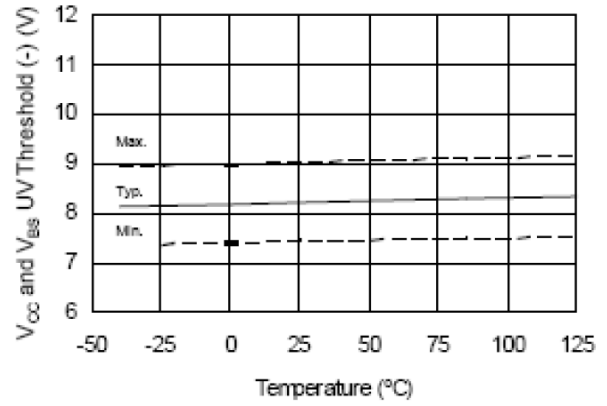


Figure 13. V_{CC} and V_{BS} Undervoltage Threshold(-) vs Temperature

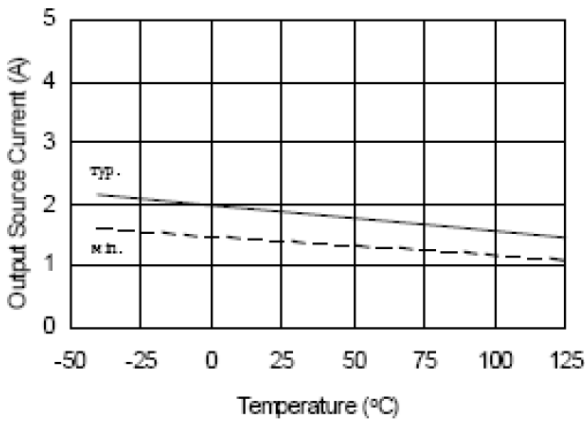


Figure 14A. Output Source Current vs Temperature

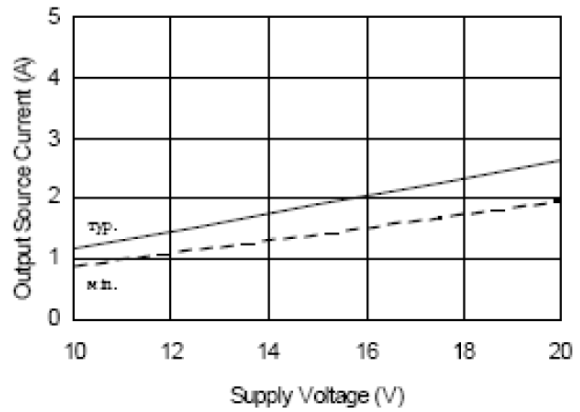


Figure 14B. Output Source Current vs Supply Voltage

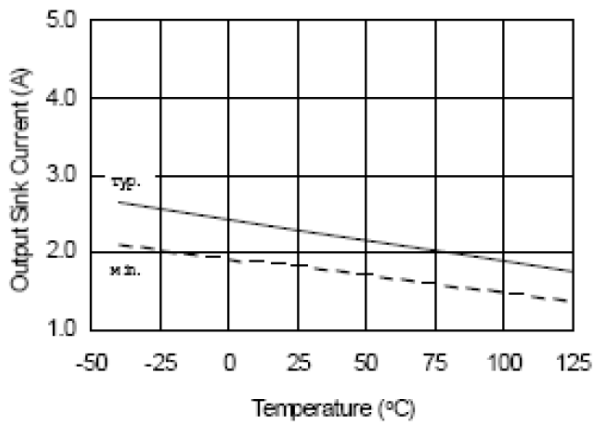


Figure 15A. Output Sink Current vs Temperature

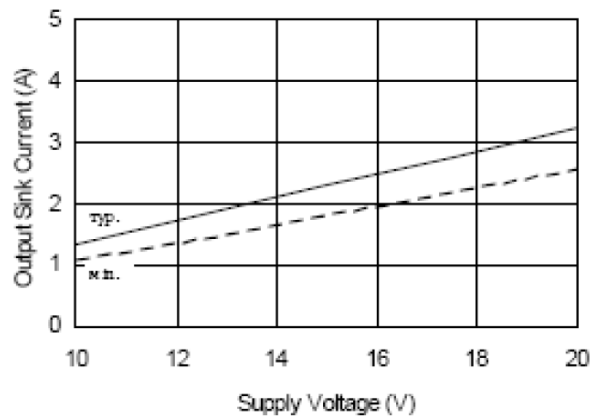
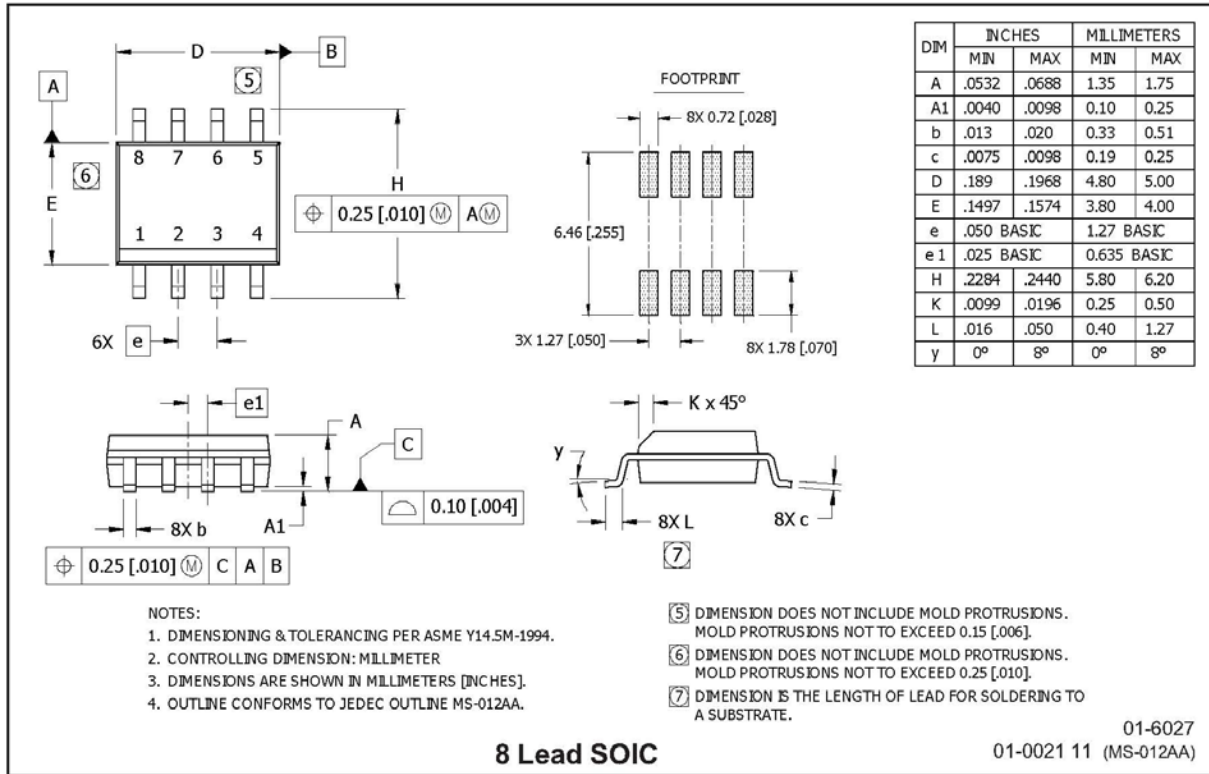
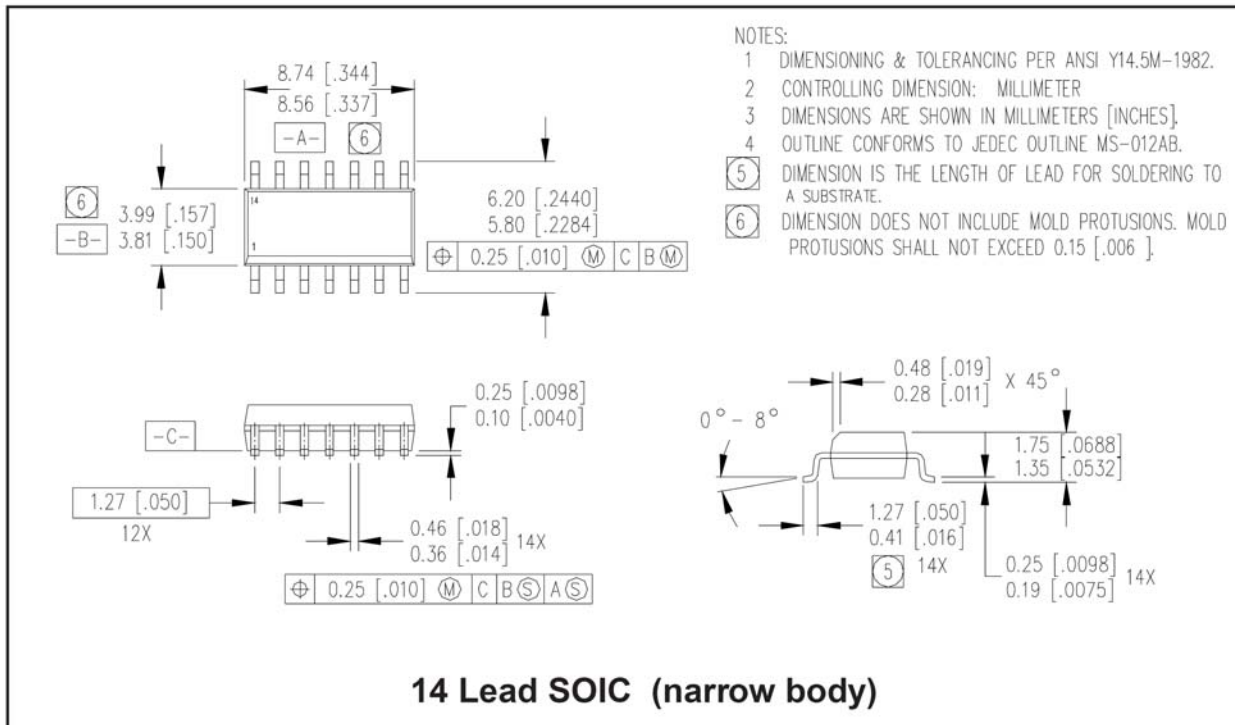


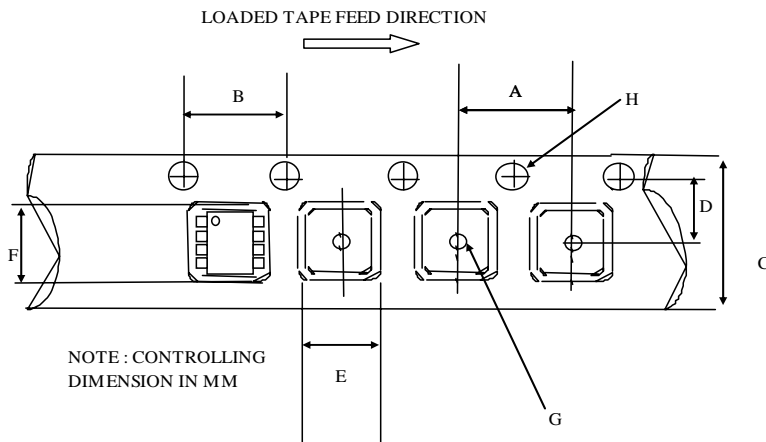
Figure 15B. Output Sink Current vs Supply Voltage

Package Details: SOIC8



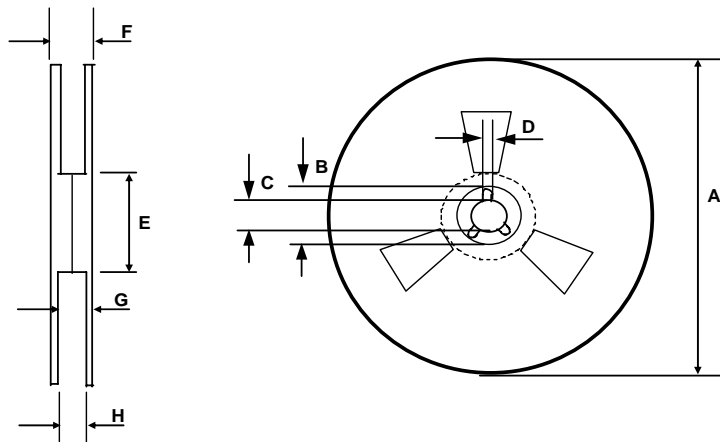
Package Details: SOIC14N





CARRIER TAPE DIMENSION FOR 8SOICN

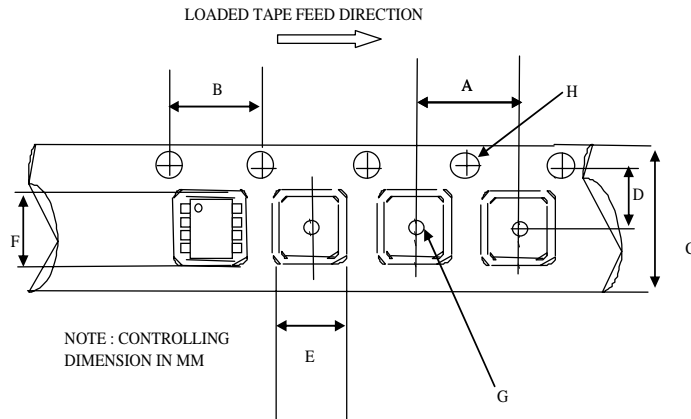
Code	Metric		Imperial	
	Min	Max	Min	Max
A	7.90	8.10	0.311	0.318
B	3.90	4.10	0.153	0.161
C	11.70	12.30	0.46	0.484
D	5.45	5.55	0.214	0.218
E	6.30	6.50	0.248	0.255
F	5.10	5.30	0.200	0.208
G	1.50	n/a	0.059	n/a
H	1.50	1.60	0.059	0.062



REEL DIMENSIONS FOR 8SOICN

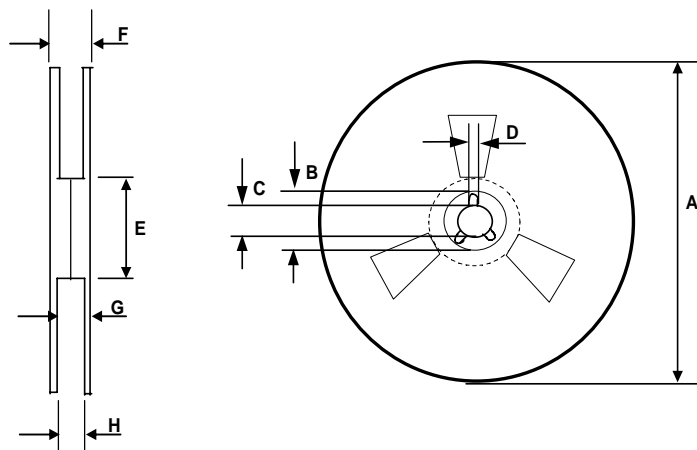
Code	Metric		Imperial	
	Min	Max	Min	Max
A	329.60	330.25	12.976	13.001
B	20.95	21.45	0.824	0.844
C	12.80	13.20	0.503	0.519
D	1.95	2.45	0.767	0.096
E	98.00	102.00	3.858	4.015
F	n/a	18.40	n/a	0.724
G	14.50	17.10	0.570	0.673
H	12.40	14.40	0.488	0.566

Tape and Reel Details: SOIC14N



CARRIER TAPE DIMENSION FOR 14SOICN

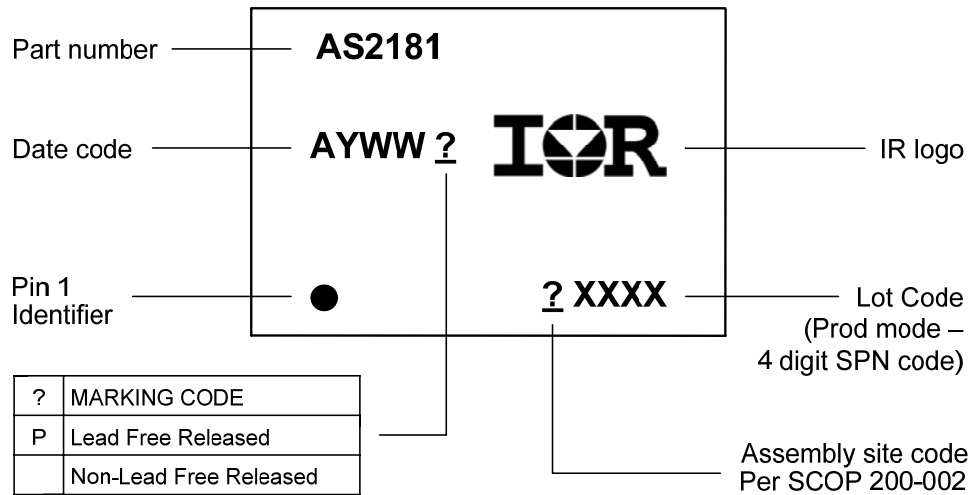
Code	Metric		Imperial	
	Min	Max	Min	Max
A	7.90	8.10	0.311	0.318
B	3.90	4.10	0.153	0.161
C	15.70	16.30	0.618	0.641
D	7.40	7.60	0.291	0.299
E	6.40	6.60	0.252	0.260
F	9.40	9.60	0.370	0.378
G	1.50	n/a	0.059	n/a
H	1.50	1.60	0.059	0.062



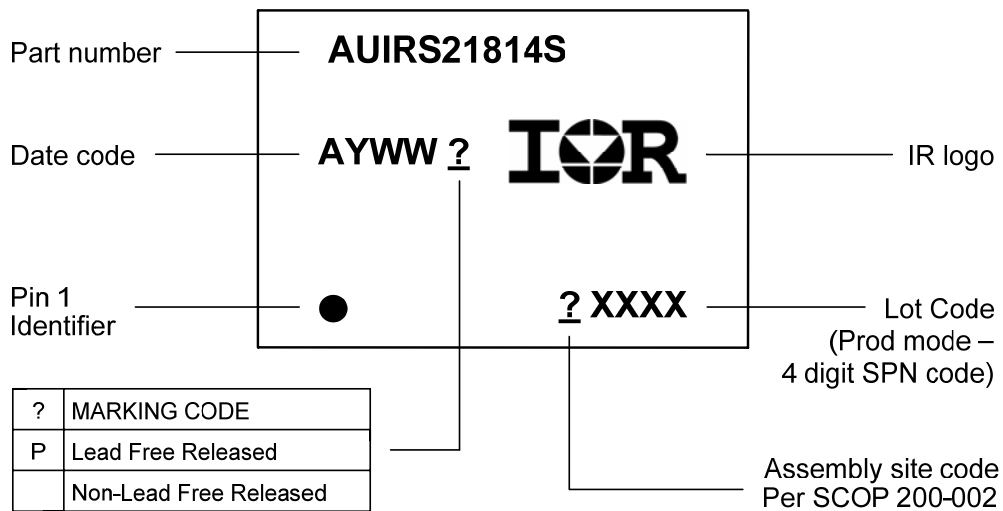
REEL DIMENSIONS FOR 14SOICN

Code	Metric		Imperial	
	Min	Max	Min	Max
A	329.60	330.25	12.976	13.001
B	20.95	21.45	0.824	0.844
C	12.80	13.20	0.503	0.519
D	1.95	2.45	0.767	0.096
E	98.00	102.00	3.858	4.015
F	n/a	22.40	n/a	0.881
G	18.50	21.10	0.728	0.830
H	16.40	18.40	0.645	0.724

SOIC8:



SOIC14N:



Base Part Number	Package Type	Standard Pack		Complete Part Number
		Form	Quantity	
AUIRS2181S	SOIC8	Tube/Bulk	95	AUIRS2181S
		Tape and Reel	2500	AUIRS2181STR
AUIRS21814S	SOIC14N	Tube/Bulk	55	AUIRS21814S
		Tape and Reel	2500	AUIRS21814STR

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For technical support, please contact IR's Technical Assistance Center

<http://www.irf.com/technical-info/>

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Revision History

Date	Comment
04/29/08	Draft
5/6/08	Converted to new automotive format
9/30/08	Reviewed and updated various missing information
10/01/08	Inserted Input/Output Pin Equivalent Circuit Diagram
Feb, 10 th , 2009	Typ application list and other minor changes
Feb. 11, 2009	Removed PDIP package versions from datasheet
Aug. 4, 2009	Updated qualification information, characterization curves
Aug. 11, 2009	Updated plot, removed characterization graphs, changes package type info
Aug. 13, 2009	Updated VIH/VIL graphs
Sep 23 rd , 2009	Typ appl. Section update; Rearranged graphs with temperature and supply characteristic, updated marking detail with p/n; added ESD passing voltage; update LU test passing current from 40mA to 80mA.
Dec. 16, 09	Changed Iqcc/Iqbs min to 15uA; added Important Notice page; changed ton typ=160ns; toff typ=200ns; tr typ=15ns; tf typ=15ns
Feb. 24, 2010	Page 6: Added I _{O25+} and I _{O25-} specification and the notes
Jul. 27, 2010	clamp diode values changed from 25V into 20V (in-out pin eq. circ. diagrams)